

MINIATURE SIGNAL RELAY EC2 SERIES

COMPACT AND LIGHTWEIGHT, SMALL MOUNTING SIZE, HIGH BREAKDOWN VOLTAGE

DESCRIPTION

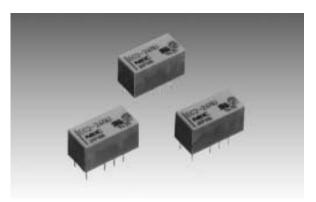
The EC2 series has reduced mounting space but sustained high-performance of NEC EA2 series. Furthermore, it complies with 2500 V surge-voltage requirement of Bellcore specification.

FEATURES

- Compact and light weight
- 2 form c contact arrangement
- $\,\circ\,$ Low power consumption
- \circ Reduced mounting space : 15 mm \times 7.5 mm
- High-breakdown voltage of coil to contacts : 1500 Vac, 2500 V (rise time : 2 μ s, fall time : 10 μ s)
- Capable of High-power switching :
- 700 Vac, 4.2 A, 4 times in case of accident
- $\,\circ\,$ UL recognized (E73266), CAS certified (LR46266)

APPLICATIONS

Electronic switching systems, PBX, terminal equipment, telephone systems.



For Right Use of Miniature Relays

DO NOT EXCEED MAXIMUM RATINGS.

Do not use relays under exceeding conditions such as over ambient temperature, over voltage and over current. Incorrect use could result in abnormal heating, damage to related parts or cause burning.

READ CAUTIONS IN THE SELECTION GUIDE.

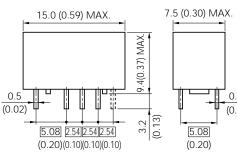
Read the cautions described in NEC's "Miniature Relays" (ER0046EJ*) when you choose relays for your application.

OUTLINE DRAWING AND DIMENSIONS

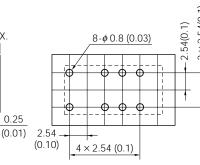
PAD LAYOUT (bottom view)

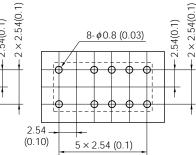
Unit : mm (inch)

Non-latch and Single coil latch



Note. General tolerance : ±0.2 (±0.008) Dimensions in _____show basic size. NJ type : Leads-2.8 mm (0.11)

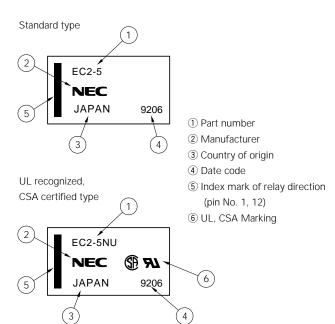




Double coil latch

Note. General tolerance : ±0.1 (±0.004)

MARKINGS



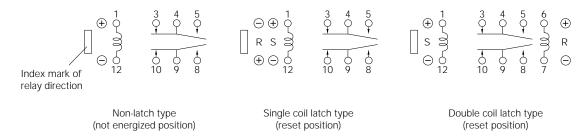
SAFETY STANDARD AND RATING

UL Recognized	CSA Certificated	
(UL508)*	(CSA C22.2 No 14)	
File No E73266	File No LR46266	
30 Vdc, 2A (Resistive) 110 Vdc, 0.3A (Resistive) 125 Vdc, 0.5A (Resistive)		

* Spacing : UL114, UL478

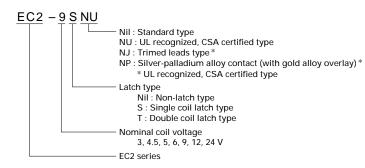
TUV Certificate (EN60255 / IEC60255)	
No. R 9751153 (Nonlatch and Single-coil-latch)	
Creepage and clearance of coil to contact is more than 2 mm. (According EN60950)	
Basic insulation class	

PIN CONFIGURATIONS (bottom view)



S : Coil polarity of set (operate) R : Coil polarity of reset (release)

PART NUMBER SYSTEM



PERFORMANCE CHARACTERISTICS

Contact Form		2 Form c	
Contact Material		Silver alloy with gold alloy overlay	
Contact Ratings	Maximum Switching Power	60 W, 125 VA	
(UL / CSA Rating)	Maximum Switching Voltage	220 Vdc, 250 Vac	
	Maximum Switching Current	2 A	
	Maximum Carrying Current	2 A	
Minimum Contact Rating	S	10 mVdc, 10 μA *1	
Initial Contact Resistance	;	50 mΩ typ. (Initial)	
	Non-Latch Type	140 mW (3 to 12 V), 200 mW (24 V)	
Nominal Operating Power	Single Coil Latch Type	100 mW	
	Single Coil Latch Type	140 mW	
Operate Time (Excluding	Bounce)	Approx. 2 ms	
Release Time (Excluding	Bounce)	Approx. 1 ms without diode	
Insulation Resistance		1000 MΩ at 500 Vdc	
	Between Open Contacts	1000 Vac (for one minute)	
Proakdown Voltago	Between Adjacent Contacts	1500 V surge (10 × 160 μs *²)	
Breakdown Voltage	Between Coil and Contact	1500 Vac (for one minute) 2500 V surge, (2 × 10 μs *3)	Double Coil 1000 Vac (for one minute) Latch type 1500 V surge ($10 \times 160 \ \mu s *^2$)
Shock Resistance		735 m / s² (misoperating) 980 m / s² (destructive failure)	
Vibration Resistance		10 to 55 Hz double amplitude of 3 mm (misoperating) 10 to 55 Hz, double amplitude of 5 mm (Destructive failure)	
Ambient Temperature		-40 to 85°C	
Coil Temperature Rise		18 degrees at nominal coil voltage (140 mW)	
	No-load	1×10^8 *4 operations (Non-latch type) 1×10^7 operations (latch type)	
Running specifications	Land	50 Vdc, 0.1 A (resistive) 1 × 10 ⁶ operations at 85°C, 2 Hz	
	Load	10 Vdc, 10 mA (resistive) 1 × 10 ⁶ operations at 85°C, 2 Hz	
Weight	ight Approx. 1.9 g		

*1 This value is reference value in the resistance load.

Minimum capacity changes depending on switching frequency and environment temperatur and the load.

*2 rise time : 10 μ s, fall time : 160 μ s

*3 rise time : 2 μ s, fall time : 10 μ s

*4 This shows a number of operation where it can be running by which a fatal defect is not caused, and a number of operation by which a steady characteristic is maintained is 1×10^7 times.

Recommended relay drive conditions

Drive under conditions. If it is impossible, please inquire to NEC.

Nonlatch type	Voltage: within $\pm 5\%$ at nominal voltage	
Single coil latch type Double coil latch type	Square pulse (rise and fall time is rapidly) Pulse height : within ±5% at nominal voltage Pulse width : More than 10 ms	Ambient temperature -40 to +85°C

PRODUCT LINEUP

Non-latch Type

Non-latch Type at 20°			
Nominal Coil	Coil	Must Operate	Must Release
Voltage	Resistance	Voltage	Voltage
(Vdc)	(Ω) ±10 %	(Vdc)	(Vdc)
3	64.3	2.25	0.3
4.5	145	3.38	0.45
5	178	3.75	0.5
6	257	4.5	0.6
9	579	6.75	0.9
12	1028	9	1.2
24	2880	18	2.4

Single-Coil Latch Type

Single-Coil Latch Type at 20 [°]			
Nominal Coil	Coil	Must Operate	Must Release
Voltage	Resistance	Voltage	Voltage
(Vdc)	(Ω) ±10 %	(Vdc)	(Vdc)
3	90	2.25	2.25
4.5	202.5	3.38	3.38
5	250	3.75	3.75
6	360	4.5	4.5
9	810	6.75	6.75
12	1440	9	9
24	5760	18	18

Double-Coil Latch Type ** (Can not be driven by revese polarity for reverse operation.)

at 20°C Nominal Coil Coil Must Operate Must Release Voltage Resistance Voltage Voltage (Vdc) (Ω) ±10 % (Vdc) (Vdc) S 64.3 2.25 _ 3 R 64.3 _ 2.25 S 145 3.38 _ 4.5 R 145 _ 3.38 S 178 3.75 _ 5 R 178 3.75 _ S 257 4.5 _ 6 R 257 _ 4.5 S 579 6.75 _ 9 R 6.75 579 _ S 1028 9 -12 R 9 1028 _ S 4114 18 _ 24 R 4114 18 _

Note * Test by pulse voltage

** S : Set coil (pin No.1...⊕, pin No.5...⊖) R: Reset coil (pin No.10...⊕, pin No.6...⊖)

The latch type relays should be initialized at appointed position before using, and should be enegized to specific polanity by a bone polabity to avoid wrong operation.

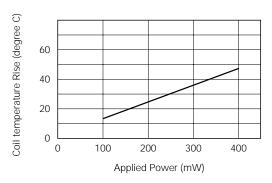
Any special coil requirement, please contact NEC for availability.

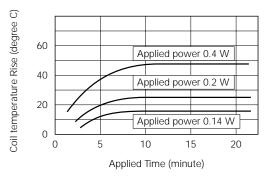


PERFORMANCE DATA

■COIL TEMPERATURE RISE

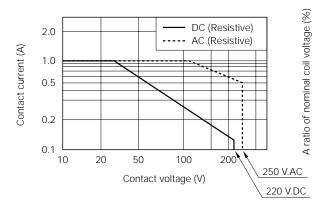
Temperature is measured by coil resistance.



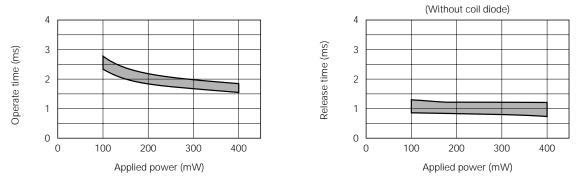


■SWITCHING CAPACITY

This is allowed maximum value. Inquiry for NEC under maximum value at continuous use.



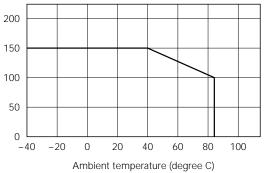
■ APPLIED VOLTAGE VS. TIMING (Sample: EC2-5NU)





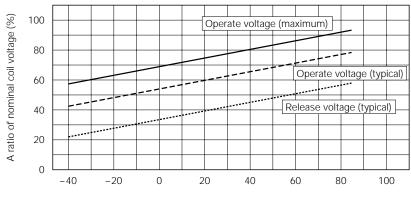
Ph (707) 996-5201 Fx (707) 996-3380 www.worldproducts.com e-mail: corpsales@worldproducts.com This is maximum value of permissible alteration. Inquiry for NEC at continuous use.

■MAXIMUM COIL VOLTAGE



■OPERATE AND RELEASE VOLTAGE VS. AMBIENT TEMPERATURE

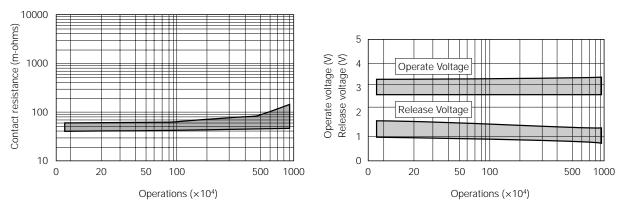
This shows a typical change of operate (release) voltage. Maximum value of operate estimated, so it must be applied more than this value for safety operation. In case of "hot start operation", please inquiry for NEC.



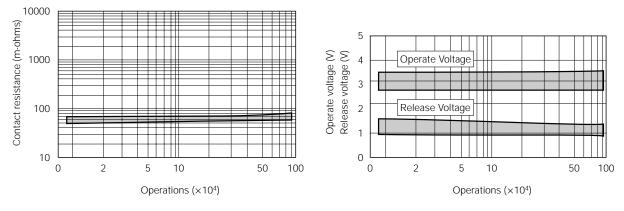
Ambient temperature (degree C)

■RUNNING TEST (Nonload)

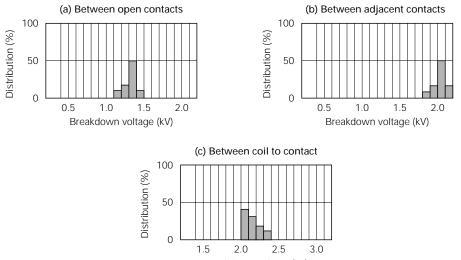
(Load: None, Driving: 5V.DC, 50 Hz, 50% duty, Ambient temperature: Room temperature, Sample: EC2-5NU 20 pieces)





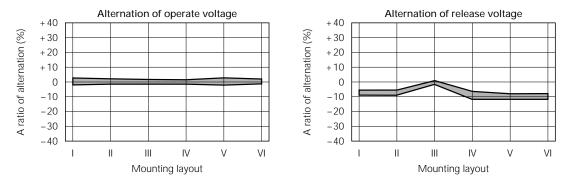


■BREAKDOWN VOLTAGE Sample: EC2-5NU 10 pieces

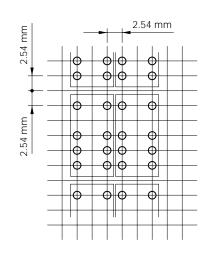


Breakdown voltage (kV)

■ALTERNATION OF VOLTAGE AT DENSELY MOUNTING (Magnet interference)

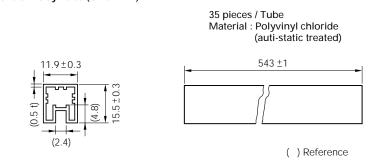




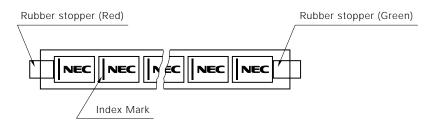


PACKAGE

Dimensions of Relay Tube (Unit : mm)



Outline of Package



NEC

Notes on Correct Use

1. Notes on contact load

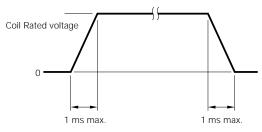
Make sure that the contact load is within the specified range; otherwise, the lifetime of the contacts will be shortened considerably. Note that the running performance shown is an example, and that it varies depending on parameters such as the type of load, switching frequency, driver circuit, and ambient temperature under the actual operating conditions. Evaluate the performance by using the actual circuit before using the relay.

2. Driving relays

- If the internal connection diagram of a relay shows + and symbols on the coil, apply the rated voltage to the relay in the specified direction. If a rippled DC current source is used, abnormalities such as beat at the coil may occur.

- The maximum voltage that can be applied to the coil of the relay varies depending on the ambient temperature. Generally, the higher the voltage applied to the coil, the shorter the operating time. Note, however, that a high voltage also increases the bounce of the contacts and the contact opening and closing frequency, which may shorten the lifetime of the contacts.

- If the driving voltage waveform of the relay coil rises and falls gradually, the inherent performance of the relay may not be fully realized. Make sure that the voltage waveform instantaneously rises and falls as a pulse.



- For a latching relay, apply a voltage to the coil according to the polarity specified in the internal connection diagram of the relay.

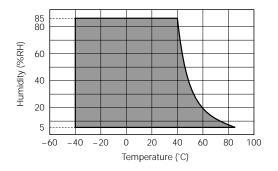
- If a current is applied to the coil over a long period of time, the coil temperature rises, promoting generation of organic gas inside the relay, which may result in faulty contacts. In this case, use of a latching relay is recommended.

- The operating time and release time indicate the time required for each contact to close after the voltage has been applied to or removed from the coil. However, because the relay has a mechanical structure, a bounce state exists at the end of the operating and release times. Furthermore, because additional time is required until the contact stabilizes after being in a high-resistance state, care must be taken when using the relay at high speeds.

3. Operating environment

- Make sure that the relay mounted in the application set is used within the specified temperature range. Use of a relay at a temperature outside this range may adversely affect insulation or contact performance.

- If the relay is used for a long period of time in highly humid (RH 85% or higher) environment, moisture may be absorbed into the relay. This moisture may react with the NOx and SOx generated by glow discharges that occur when the contacts



are opened or closed, producing nitric or sulfuric acid. If this happens, the acid produced may corrode the metallic parts of the relay, causing operational malfunction.

- Because the operating temperature range varies depending on the humidity, use the relay in the temperature range illustrated in the figure below. Prevent the relay from being frozen and avoid the generation of condensation.

- The relay maintains constant sealability under normal atmospheric pressure (810 to 1,200 hpa). Its sealability may be degraded or the relay may be deformed and malfunction if it is used under barometric conditions exceeding the specified range.

- The same applies when the relay is stored or transported. Keep the upper-limit value of the temperature to which the relay is exposed after it is removed from the carton box to within 50°C.

 If excessive vibration or shock is applied to the relay, it may malfunction and the contacts remain closed. Vibration or shock applied to the relay during operation may cause considerable damage to or wearing of the contacts. Note that operation of a snap switch mounted close to the relay or shock due to the operation of magnetic solenoid may also cause malfunctioning.

4. Notes on mounting relays

 When mounting a relay onto a PC board using an automatic chip mounter, if excessive force is applied to the cover of the relay when the relay is chucked or inserted, the cover may be damaged or the characteristics of the relay degraded. Keep the force applied to the relay to within 1 kg.

- Avoid bending the pins to temporarily secure the relay to the PC board. Bending the pins may degrade sealability or adversely affect the internal mechanism.

- It is recommended to solder the relay onto a PC board under the following conditions:

<1> Reflow soldering

Refer to the recommended soldering temperature profile.

<2> Flow soldering

Solder temperature: 250°C max., Time: 5 to 10 seconds, Preheating: 100°C max./1 minute max.

<3> Manual soldering

Solder temperature: 350°C, Time: 2 to 3 seconds

- Ventilation immediately after soldering is recommended. Avoid immersing the relay in cleaning solvent immediately after soldering due to the danger of thermal shock being applied to the relay.

- Use an alcohol-based or water-based cleaning solvent. Never use thinner and benzene because they may damage the relay housing.

- Do not use ultrasonic cleaning because the vibration energy generated by the ultrasonic waves may cause the contacts to remain closed.

5. Handling

 Relays are packaged in magazine cases for shipment. If a space is created in the case after some relays have been removed, be sure to insert a stopper to secure the remaining relays in the case. If relays are not well secured, vibration during transportation may cause malfunctioning of the contacts.

- Exercise care in handling the relay so as to avoid dropping it or allowing it to fall. Do not use a relay that has been dropped. If a relay drops from a workbench to the floor, a shock of 9,800 m/s2 (1,000 G) or more is applied to the relay, possibly damaging its functions. Even if a light shock has been applied to the relay, thoroughly evaluate its operation before using it. - Latching relays are factory-set to the reset state for shipment. A latching relay may be set, however, by vibration or shock applied while being transported. Be sure to forcibly reset the relay before using it in the application set. Also note that the relay may be set by unexpected vibration or shock when it is used in a portable set.

- The sealability of a surface-mount relay may be lost if the relay absorbs moisture and is then heated during soldering. When storing relays, therefore, observe the following points: <1> The storage humidity must be no more than 70% RH. The recommended storage period is 3 months maximum.

<2> To store the relay for 3 months or longer, keep the storage humidity to within 50% RH. Do not store the relay for more than 6 months.

No part of this document may be copied or reproduced in any form or by any means without the prior written consent of NEC Corporation. NEC Corporation assumes no responsibility for any errors which may appear in this document.

NEC Corporation does not assume any liability for infringement of patents, copyrights or other intellectual property rights of third parties by or arising from use of a device described herein or any other liability arising from use of such device. No license, either express, implied or otherwise, is granted under any patents, copyrights or other intellectual property rights of NEC Corporation or others.

While NEC Corporation has been making continuous effort to enhance the reliability of its electronic components, the possibility of defects cannot be eliminated entirely. To minimize risks of damage or injury to persons or property arising from a defect in an NEC electronic component, customers must incorporate sufficient safety measures in its design, such as redundancy, fire-containment, and antifailure features. NEC devices are classified into the following three quality grades:

"Standard", "Special", and "Specific". The Specific quality grade applies only to devices developed based on a customer designated "quality assurance program" for a specific application. The recommended applications of a device depend on its quality grade, as indicated below. Customers must check the quality grade of each device before using it in a particular application.

Standard: Computers, office equipment, communications equipment, test and measurement equipment, audio and visual equipment, home electronic appliances, machine tools, personal electronic equipment and industrial robots

Special: Transportation equipment (automobiles, trains, ships, etc.), traffic control systems, anti-disaster systems, anti-crime systems, safety equipment and medical equipment (not specifically designed for life support)

Specific: Aircrafts, aerospace equipment, submersible repeaters, nuclear reactor control systems, life support systems or medical equipment for life support, etc.

The quality grade of NEC devices is "Standard" unless otherwise specified in NEC's Data Sheets or Data Books. If customers intend to use NEC devices for applications other than those specified for Standard quality grade, they should contact an NEC sales representative in advance.

(Note)

- (1) "NEC" as used in this statement means NEC Corporation and also includes its majority-owned subsidiaries.
- (2) "NEC electronic component products" means any electronic component product developed or manufactured by or for NEC (as defined above).

DE0202